

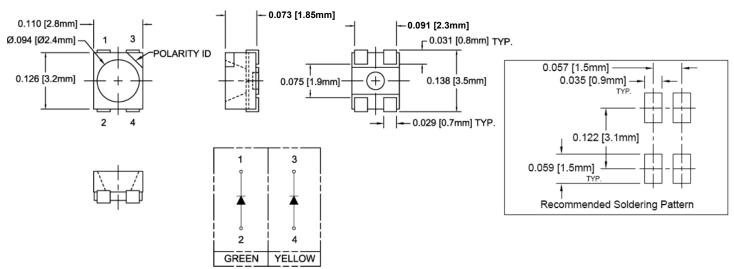
- ◆ Industry Standard PLCC4 Footprint
- ♦ 2 Chips in One Low Profile Package
- ♦ High Luminous Intensity
- ♦ Wide Viewing Angle
- ♦ High Power Efficiency



Bivar SMTL4 Bi-Color LED combines two chips in a single package and is offered in an industry standard PLCC4 footprint. The SMTL4 LED has a water clear lens for high luminous intensity and wide viewing angle making them ideal for small scale applications such as illumination, general indication, and backlighting. The robust package is ideal for harsh working environments and can be clustered in LED arrays for high luminous applications. Low power consumption and excellent long life reliability are suitable for battery powered equipment. Bivar SMTL4 LED is packaged in standard tape and reels for pick and place assemblies.

| Part Number | Material | Emitted Color | Luminous Intensity Typ. mcd | Lens Color | Viewing Angle | |
|-------------|-----------|---------------|--------------------------------|-------------|---------------|--|
| SMTL4-BC-YG | GaAsP | Yellow | 14.5 | Water Clear | 120° | |
| | GaP Green | | 28.5 | Water Clear | 120 | |

Outline Dimensions



Outline Drawings Notes:

- 1. All dimensions are in inches [millimeters].
- 2. Standard tolerance: ±0.010" unless otherwise noted.









Absolute Maximum Ratings

T_A = 25°C unless otherwise noted

| Power Dissipation | 78 mW |
|---|-------------|
| Forward Current (DC) | 30 mA |
| Peak Forward Current ¹ | 100 mA |
| Reverse Voltage | 5 V |
| Derating Linear From 25°C | 0.4 mA/°C |
| Operating Temperature Range | -40 ~ +85°C |
| Electrostatic Discharge Classification (HBM) | 2000 V |
| Storage Temperature Range | -40 ~ +85°C |
| Lead Soldering Temperature (1.6 mm from body) ² | 260°C |

Notes: 1. 10% Duty Cycle, Pulse Width ≤ 0.1 msec. 2. Solder time less than 5 seconds at temperature extreme.

Handling: Reflow soldering must not be performed more than twice. Hand soldering must not be performed more than once.

Sensitive to static electricity or surge voltage. Proper handling required to avoid ESD damage and impair LED reliability.

Electrical / Optical Characteristics

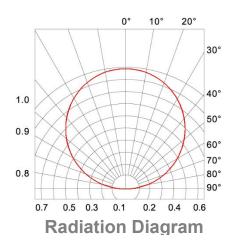
T_A = 25°C & I_F = 20 mA unless otherwise noted

| Emitting Color | Forward y Voltage (V) ¹ | | Recommend Forward Current (mA) | | Reverse Current (μΑ) V _R =5V | Dominant Wavelength (nm)² | | Luminous Intensity Iv (mcd) ³ | | Viewing Angle 2 Θ ½ (deg) | | | | |
|-------------------|---------------------------------------|-----|--------------------------------------|-----|--|------------------------------|-----|---|-----|------------------------------------|------|------|------|-----|
| | MIN | TYP | MAX | MIN | TYP | MAX | MAX | MIN | TYP | MAX | MIN | TYP | MAX | TYP |
| Yellow | / | 1.9 | 2.6 | 1 | 20 | / | 10 | 585 | 588 | 591 | 9.0 | 14.5 | 22.5 | 120 |
| Green | / | 1.9 | 2.6 | / | 20 | / | 10 | 568 | 570 | 574 | 18.0 | 28.5 | 45.0 | 120 |

Notes: 1. Tolerance of forward voltage: $\pm 0.05 V$.

Directivity Radiation

T_A = 25°C unless otherwise noted



Bivar reserves the right to make changes at any time without notice

^{2.} Tolerance of dominant wavelength: -1nm of MIN and +1 of MAX,

^{3.} Tolerance of luminous intensity: ±15%.



Typical Electrical / Optical Characteristics

T_A = 25°C unless otherwise noted

Relative Spectrum Emission I_{rel} = f (I), T_A = 25°C , I_F = 20 mA V(I) = Standard eye response curve

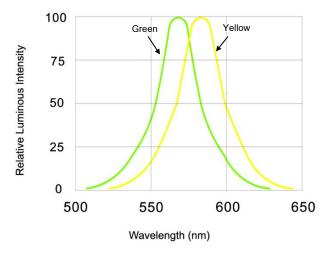


Fig.1 Relative Luminous Intensity vs. Wavelength

Forward Current $I_F = f(V_F)$ $T_A = 25$ °C

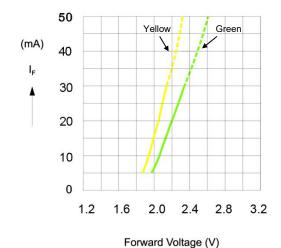


Fig.2 Forward Current vs. Forward Voltage

Relative Luminous Intensity I_V/I_V (20 mA) = f (I_F) T_A = 25°C

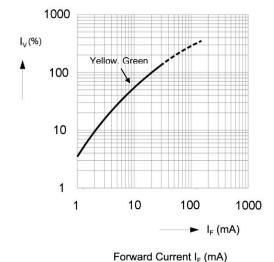
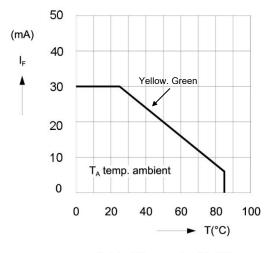


Fig.3 Relative Luminous Intensity vs. Forward Current

Ambient Temperature vs. Allowable Forward Current



Ambient Temperature T_A (°C)

Fig.4 Forward Current vs. Ambient Temperature

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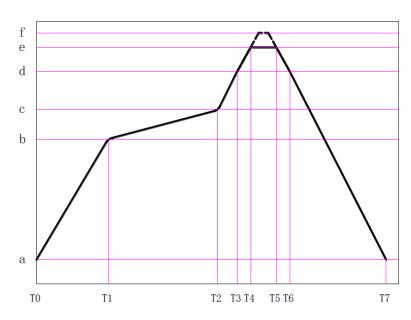
Soldering Iron

- 1. Temperature at tip of iron: 300 °C Max. (25 W Max.)
- 2. Soldering Time: 5 ± 1 sec.

Recommended Soldering Conditions

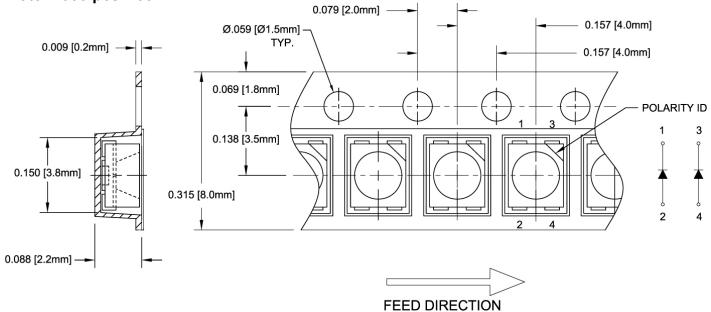
| Temp. (°C) | | Time (sec) | | |
|------------|----------|--------------|---------------|--|
| а | 25 | T0~T1 | Max. 3 °C/sec | |
| b | 150 | T1~T2 | 90~130 sec | |
| С | 200 | T2~T4 | Max. 3 °C/sec | |
| d | 220 | T3~T6 | Max. 50 sec | |
| е | 245 | | | |
| f | Max. 260 | | Max. 10 sec | |
| | | T5~T7 | Max3 °C/sec | |
| Belt Speed | | 70~90 cm/min | | |

Note: Will vary based on equipment and process used.



Tape and Reel Dimensions

Note: 2000 pcs/Reel

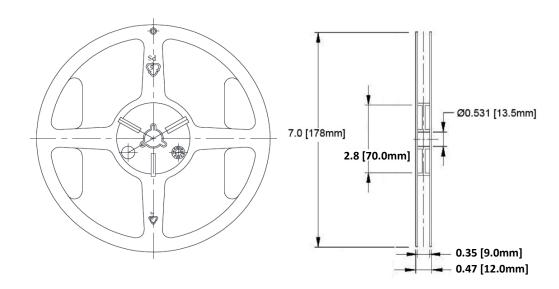


Outline Drawings Notes:

- 1. All dimensions are in inches [millimeters].
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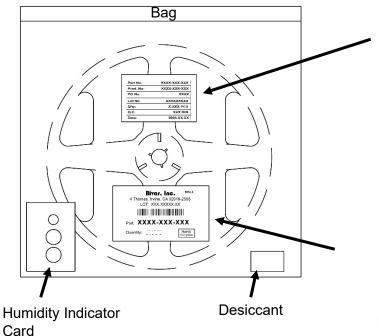
Outline Drawings Notes:

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- 2. Standard tolerance unless otherwise noted: X.XXX ± 0.010"

Packaging and Labeling Plan

Note: 1 Reel / Bag

Sealed ESD and Moisture Barrier



| Part No. | XXXX-XXX-XXX |
|-----------|--------------|
| Prod. No. | XXXX-XXX-XXX |
| PO No. | xxxx |
| Lot No. | XXXXXXXX |
| Q'ty: | X.XXX PCS |
| Q.C. | XXX BIN |
| Date: | 2008.XX.XX |
| | |

Internal Quality Control Label

Bivar. Inc.

MSL4

4 Thomas, Irvine, CA 92618-2593 LOT: XXX.XXXXXXXX



Part: XXXX-XXX

Quantity: X.XXX



Bivar Standard Packaging Label